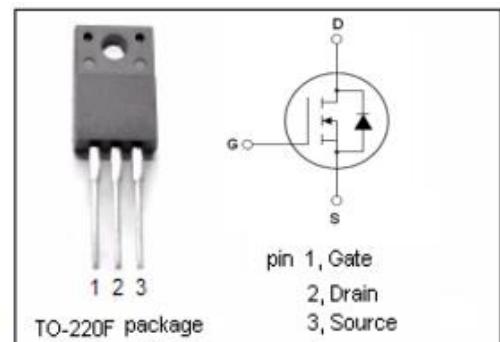


isc N-Channel MOSFET Transistor

2SK2645

DESCRIPTION

- Drain Current $I_D = 9A @ T_c=25^\circ C$
- Drain Source Voltage-
: $V_{DSS} = 600V$ (Min)
- Fast Switching Speed
- 100% avalanche tested
- Minimum Lot-to-Lot variations for robust device performance and reliable operation

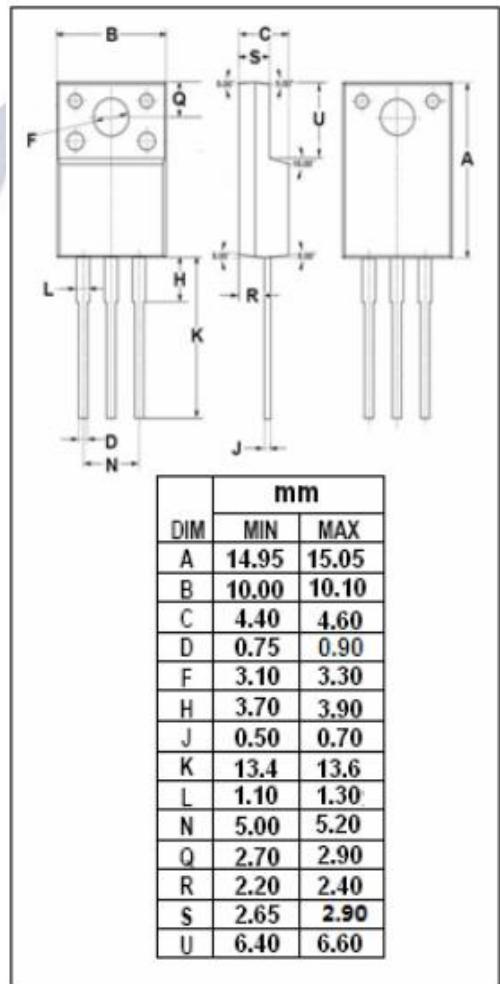


APPLICATIONS

- Designed for high efficiency switch mode power supply.

ABSOLUTE MAXIMUM RATINGS($T_c=25^\circ C$)

SYMBOL	PARAMETER	VALUE	UNIT
V_{DSS}	Drain-Source Voltage ($V_{GS}=0$)	600	V
V_{GS}	Gate-Source Voltage	± 30	V
I_D	Drain Current-continuous@ $T_c=25^\circ C$	9	A
$I_{D(puls)}$	Pulse Drain Current	32	A
P_{tot}	Total Dissipation@ $T_c=25^\circ C$	50	W
T_j	Max. Operating Junction Temperature	150	°C
T_{stg}	Storage Temperature Range	-55~150	°C



• THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	MAX	UNIT
$R_{th\ j-c}$	Thermal Resistance, Junction to Case	3.47	°C/W
$R_{th\ j-a}$	Thermal Resistance, Junction to Ambient	62.5	°C/W

isc N-Channel MOSFET Transistor**2SK2645****• ELECTRICAL CHARACTERISTICS ($T_c=25^\circ\text{C}$)**

SYMBOL	PARAMETER	CONDITIONS	MIN	TYPE	MAX	UNIT
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}= 0$; $I_D = 250\mu\text{A}$	600			V
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}}= V_{\text{GS}}$; $I_D=250\mu\text{A}$	3		4.5	V
V_{SD}	Diode Forward On-Voltage	$I_S=9\text{A}$; $V_{\text{GS}}= 0$			1.5	V
$R_{\text{DS}(\text{on})}$	Drain-Source On-Resistance	$V_{\text{GS}}= 10\text{V}$; $I_D=4\text{A}$			1.2	Ω
I_{GSS}	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 30\text{V}$; $V_{\text{DS}}= 0$			± 0.1	μA
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}= 600\text{V}$; $V_{\text{GS}}= 0$			500	μA